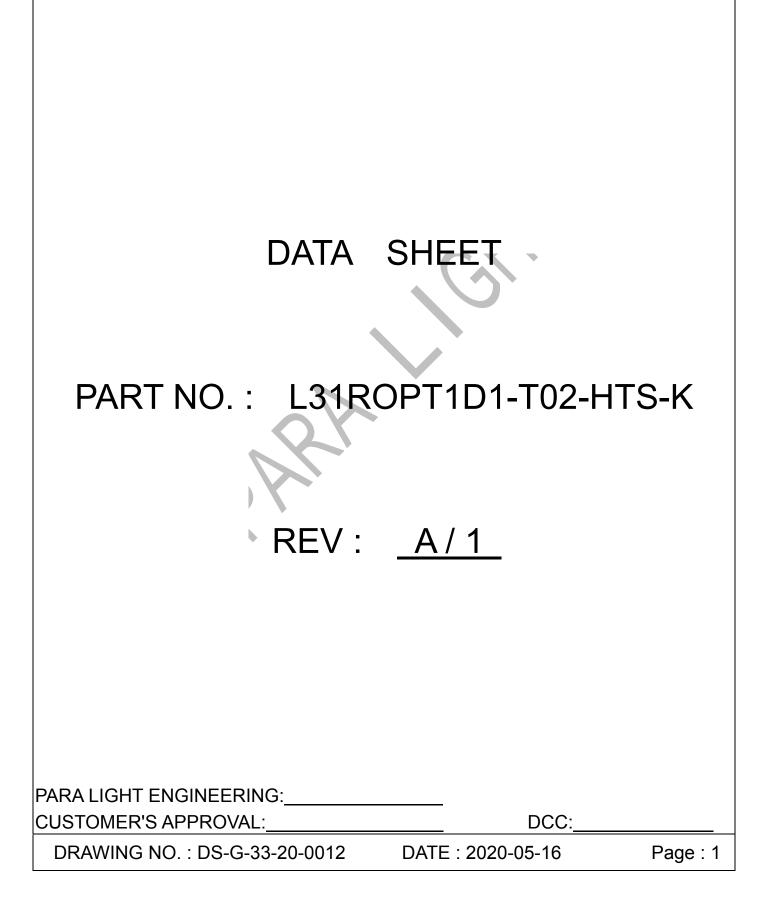


PARA LIGHT ELECTRONICS CO., LTD.

11F., No. 8, Jiankang Rd., Zhonghe Dist., New Taipei City 235, Taiwan,Tel: 886-2-2225-3733Fax: 886-2-2225-4800E-mail: para@para.com.twwww.paralighttaiwan.com





L31ROPT1D1-T02-HTS-K

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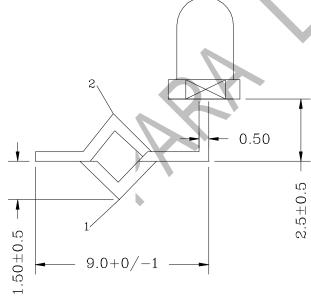
PACKAGE DIMENSIONS

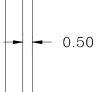
ITEM	MATERIALS
RESIN	Epoxy Resin
LEAD FRAME	Sn Plating iron Alloy

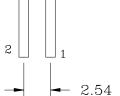
Note:

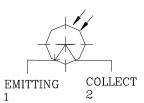
- 1.All Dimensions are in millimeters.
- 2.Tolerance is ±0.25mm(0.010 ") Unless otherwise specified.
- 3. Protruded resin under flange

is 1.5mm(0.059 ") max.









DATE : 2020-05-16



L31ROPT1D1-T02-HTS-K

REV:A/1

FEATURES

- * WIDE RANGE COLLECTOR CURRENTS
- * LENSED FOR HIGH SENSITIVITY
- * HIGH-OUTPUT POWER
- * HIGH-SPEED RESPONSE

* THE PRODUCTION IS SUBJECT TO THE STANDARD OF SONY SS-00259 AND GREEN PRODUCT.

* Pb FREE PRODUCTS

CHIP MATERIALS

* SILICON

ABSOLUTE MAXIMUM RATING : (Ta = 25°C)

SYMBOL	PARAMETER	MAX	UNIT
PD	PD Power Dissipation Per Chip		mW
V(BR)CEO	Collector-Emitter Voltage	30	V
Topr	Operating Temperature Range	erating Temperature Range -40°C to 85°C	
Tstg	Storage Temperature Range	-40°C to 85°C	

ELECTRO-OPTICAL CHARACTERISTICS : (Ta = 25°C)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
BVCEO	Collector-Emitter Breakdown Voltage	$Ic = 100\mu A$ Ee = 0 mw/cm ²	30			V
BVECO	Emitter-Collector Breakdown Voltage	IE=100μA Ee= 0 mw/cm ²	3			V
ICEO	Collector Dark Current	VCE=10V Ee=0 mw/cm ²			100	nA
VCE(S)	Collector-Emitter Saturation Voltage	IC=2mA Ee=0.5 mw/cm ²			0.4	V
TR/TF	Rise / Fall Time	VCE=5V IC=1mA RL=1000Ω		15/15		uS
IC	On Stat Collector Current	VCE=5V Ee=0.1 mw/cm ²		3		mA
λΡ	Spectral Sensitivity Wavelength			940		nm

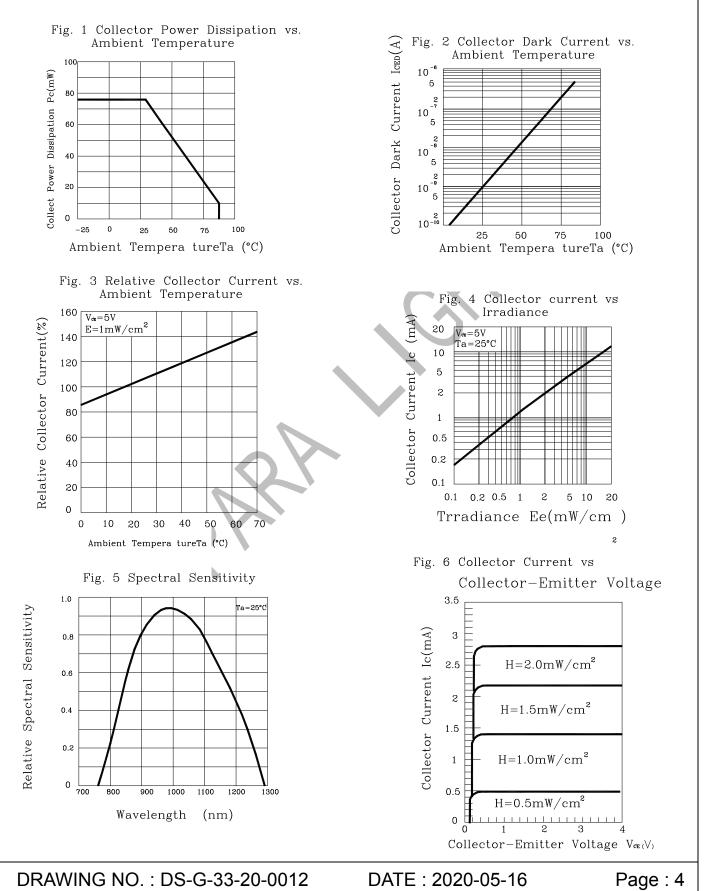
DRAWING NO. : DS-G-33-20-0012 DATE : 2020-05-16

Page: 3



L31ROPT1D1-T02-HTS-K

REV:A/1



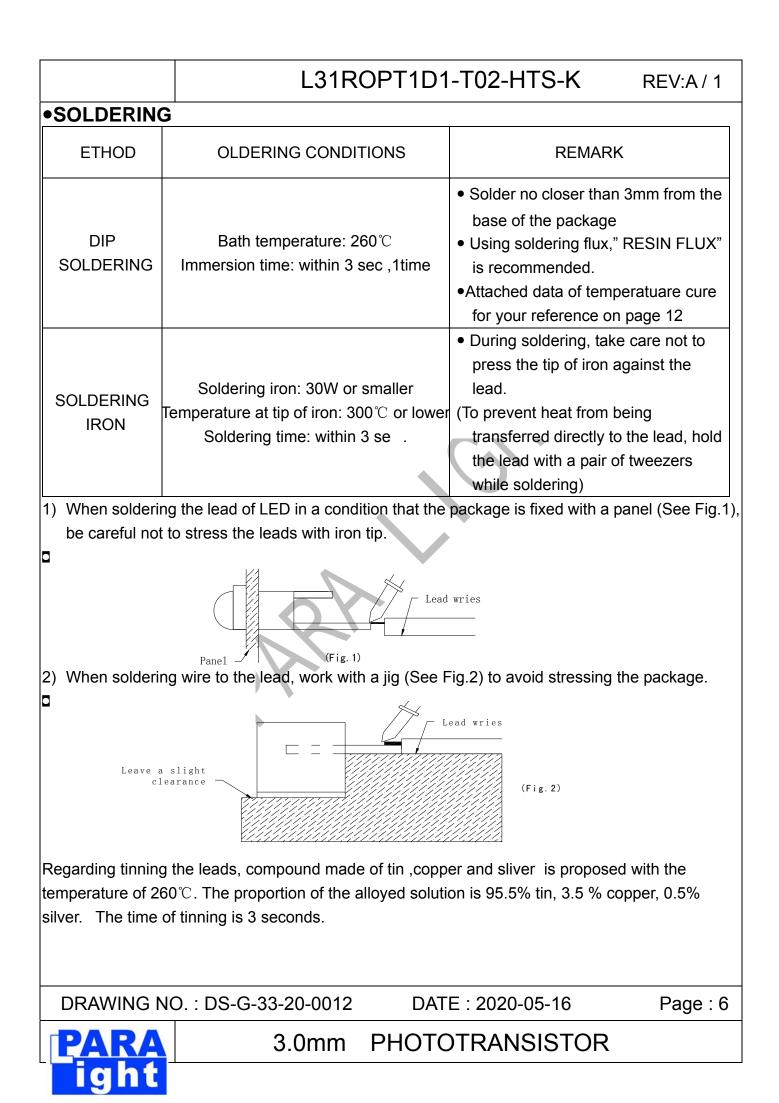


L31ROPT1D1-T02-HTS-K

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Label Explanation

PARA 光鼎电子	-股份有限公司					
PARA LIGHT ELECTRONICS CO., LTD.						
PART NO :						
LOT NO :	INSPECTED					
BIN :						
Q'TY:	PCS					
N. W :	g					
PART NO. : L31ROPT1D1-T Refer to page 1 LOT NO. : E L L 4 A B C E AE: For Serial number BL: Local F: Foreign CL: LAMP DYear EMonth FSerial number Ic Bin	3 7 0009					
测试条件	测试项目	分 BIN 要求				
Ee=0,Ic=100µA,5ms	集-射极崩溃电压 Vceo	Vceo>30V				
Ee=0,Ie=100µA,5ms	射-集极崩溃电压 Veco	Veco>5V				
Ee=0,Vce=10V,5ms						
Ee=0.1mw/cm ² ,Vce=5V						
Ee=0.1mw/cm ² ,Vce=5V						
Ee=0.1mw/cm²,Vce=5V 集-射极光电流 lc,E 等级 3.6-4.6mA						
Ee=0.1mw/cm ² ,Vce=5V 集-射极光电流 lc,F 等级 4.6-5.6mA						
Ee=0.1mw/cm ² ,Vce=5V	集-射极光电流 lc,G 等级	5.6-7.6mA				
DRAWING NO. : DS-G-33-2	0-0012 DATE : 202 Omm PHOTOTRA		Page : 5			
Ignt						



L31ROPT1D1-T02-HTS-K RFV[·]A / 1 3) Similarly, when a jig is used to solder the LED to PC board, take care as much as possible to avoid stressing the leads (See Fig.3). PC board

(Fg.)3

jig

- 4) Repositioning after soldering should be avoided as much as possible. If inevitable: select a best-suited method that assures the least stress to the LED.
- Lead cutting after soldering should be performed only after the LED temperature has returned to normal temperature.

STORAGE

- 1) The LEDs should be stored at 30 $^\circ$ C or less and 70% RH or less after being shipped from PARA and the storage life limit is 1 year .
- PARA LED lead frames are comprised of a tin plated iron alloy. The surface may be affected by environments which contain corrosive gases and so on. Please avoid conditions which may cause the LEDs to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- 3) Please avoid rapid changes in ambient temperature, especially, in high humidity environments where condensation can occur.



L31ROPT1D1-T02-HTS-K

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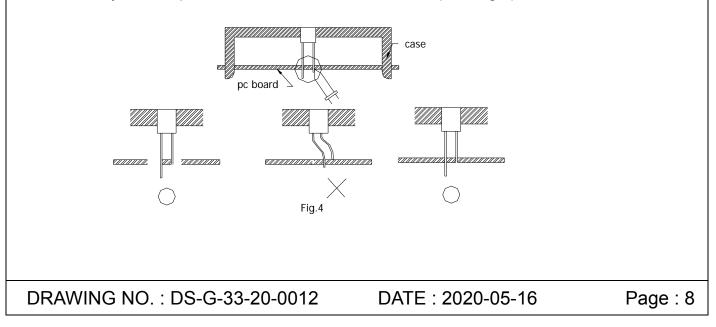
• STATIC ELECTRICITY

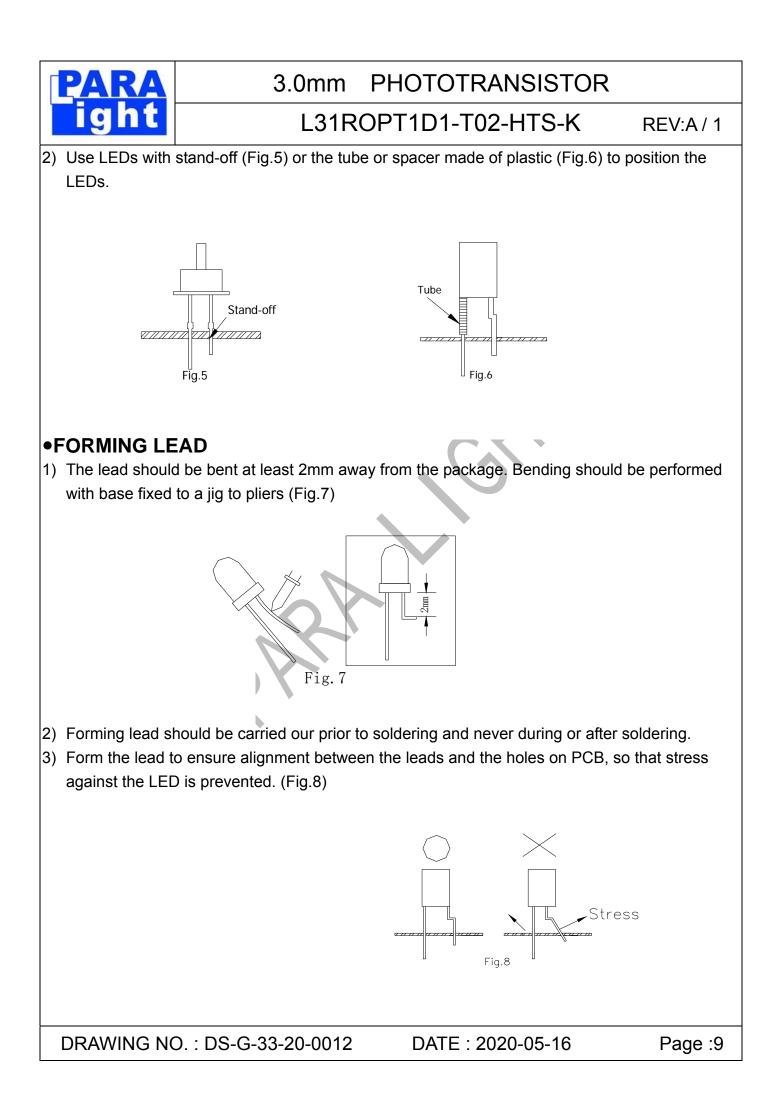
- Static electricity or surge voltage damages the LEDs.
 It is recommended that a wrist band and an anti-electrostatic glove be used when handling the LEDs.
- 2) All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the LED mounting equipment.
- 3) When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity. To find static-damaged LEDs, perform a light-on test or a VF test at a lower current (below 1mA is recommended).
- 4) Damaged LEDs will show some unusual characteristics such as the leakage current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.

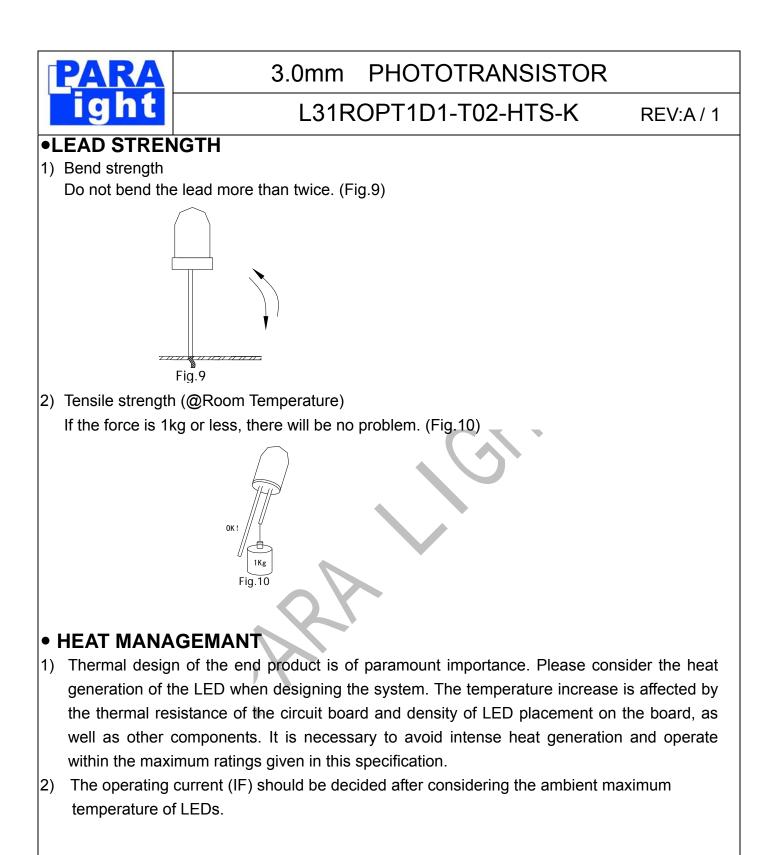
Criteria : (VF>2.0V at IF=0.5mA)

•LED MOUNTING METHOD

1) When mounting the LED to a housing, as shown on Fig.4, ensure that the mounting holes on the PC board match the pitch of the leads correctly. Tolerance of dimensions of the respective components including the LEDs should be taken into account especially when designing the housing, PC board, etc. to prevent pitch misalignment between the leads and holes on PCB, the diameter of the holes should be slightly larger than the size of the lead. Alternatively, the shape of the holes could be made oval. (See Fig.4)







Page :10



L31ROPT1D1-T02-HTS-K

REV:A/1

•CHEMICAL RESISTANCE

- 1) Avoid exposure to chemicals as it may attack the LED surface and cause discoloration.
- When washing is required, refer to the following table for the proper chemical to be used. (Immersion time: within 3 minutes at room temperature.)

SOLVENT	ADAPTABILITY
Freon TE	\odot
Chlorothene	\times
Isopropyl Alcohol	\odot
Thinner	\times
Acetone	\times
Trichloroethyl ne	×
- · · · · · · · · · · · · · · · · · · ·	

 \odot --Usable X--Do not use.

•OTHER CONSIDERTIONS

- NOTE: Influences of ultrasonic cleaning of the LED resin body differ depending on factors such as the oscillator output, size of the PC board and the way in which the LED is mounted. Therefore, ultrasonic cleaning should only be performed by confirming an ultrasonic cleaning trial run.
- 1) Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- 2) The LEDs described in this data sheet are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult PARA's sales staff in advance for information on the applications in which exceptional quality and reliability are required , particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, spacecraft, automobiles, traffic control equipment etc).
- 3) The formal specifications must be exchanged and signed by both parties before large volume purchase begins.



L31ROPT1D1-T02-HTS-K

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LED Lamps: Part Number Rules

